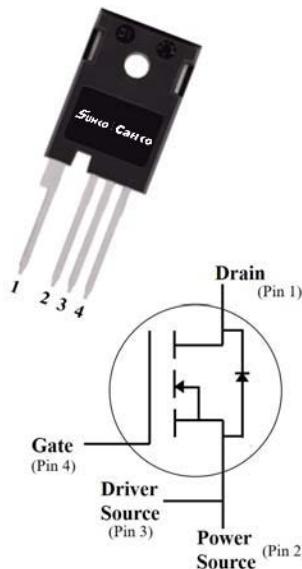


**Silicon Carbide Power MOSFET (N-Channel Enhancement)**

$V_{DS}$	1200V
$I_D(25^\circ\text{C})$	63A
$R_{DS(on)}$	40mΩ

**Features**

- High speed switching
- Essentially no switching losses
- Reduction of heat sink requirements
- Maximum working temperature at 175 °C
- High blocking voltage
- Fast Intrinsic diode with low recovery current
- High-frequency operation
- Halogen free,

**Typical Applications**

Typical applications are in power factor correction(PFC), solar inverter, uninterruptible power supply, motor drives, photovoltaic inverter, electric car and charger.

**Mechanical Data**

- **Package:** TO247-4L
- **Terminals:** Tin plated leads
- **Polarity:** As marked

**■Maximum Ratings ( $T_c=25^\circ\text{C}$  Unless otherwise specified)**

PARAMETER	SYMBOL	UNIT	VALUE	TEST CONDITIONS	NOTE
Device marking code				D212040NCFG1	
Drain source voltage @ $T_j=25^\circ\text{C}$	$V_{DS,max}$	V	1200	$V_{GS}=0\text{ V}, I_D=100\mu\text{A}$	
Gate source voltage @ $T_j=25^\circ\text{C}$	$V_{GS,max}$	V	-10/+22	Absolute maximum values	
Gate source voltage @ $T_j=25^\circ\text{C}$	$V_{GS,op}$	V	-5/+18	Recommended operational values	Note1、2
Continuous drain current @ $T_c=25^\circ\text{C}$	$I_D$	A	63	$V_{GS}=18\text{V}, T_c=25^\circ\text{C}$	Fig.18
Continuous drain current @ $T_c=100^\circ\text{C}$			41	$V_{GS}=18\text{V}, T_c=100^\circ\text{C}$	
Pulsed drain current	$I_{D(pulsed)}$	A	160	Pulse width $t_p$ limited by $T_{j,max}$	Fig.23
Avalanche energy, Single Pulse	$E_{AS}$	mJ	650	$V_{DD}=75\text{V}, L=10\text{mH}$	
Power Dissipation	$P_{TOT}$	W	333	$T_c=25^\circ\text{C}, T_j = 175^\circ\text{C}$	Fig.17
Power Dissipation			144	$T_c=110^\circ\text{C}, T_j = 175^\circ\text{C}$	
Operating junction and Storage temperature range	$T_j, T_{stg}$	°C	-55 to +175		
Soldering temperature	$T_L$	°C	260	1.6mm (0.063") from case for 10s	
Mounting torque	$T_M$	Nm	0.6	M3 screw Maximum of mounting process: 3	

## ■ Static Electrical Characteristics (Tc=25°C unless otherwise specified)

PARAMETER	SYMBOL	UNIT	Min.	Typ.	Max.	Test Conditions	Note
Gate threshold voltage	V <sub>GS(th)</sub>	V	2.0	2.5	4.0	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> = 10mA	Fig.4, 11
				2.0		V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> = 10mA, T <sub>j</sub> =175°C	
Drain source breakdown voltage	V <sub>(BR)DSS</sub>	V	1200			V <sub>GS</sub> =0, I <sub>D</sub> =100uA	
Zero gate voltage drain current	I <sub>DSS</sub>	uA		1	10	V <sub>DS</sub> =1200V, V <sub>GS</sub> = 0V	Fig.16
Gate source leakage current	I <sub>GSS</sub>	nA			100	V <sub>GS</sub> = 18V, V <sub>DS</sub> =0V	
Current drain source on-state resistance	R <sub>DS ON</sub>	mΩ		42	52	V <sub>GS</sub> =18V, I <sub>D</sub> =40A	Fig.5, 6, 7
				72		V <sub>GS</sub> =18V, I <sub>D</sub> =40A, T <sub>j</sub> =175°C	
Internal gate resistance	R <sub>g</sub>	Ω		1.8	5.0	f=1MHz	
Diode forward voltage	V <sub>SD</sub>	V		4.0		V <sub>GS</sub> =-5V, I <sub>SD</sub> =20A	Fig.8
				3.4		V <sub>GS</sub> =0V, I <sub>SD</sub> =20A T <sub>j</sub> =175°C	Fig.9
Transconductance	g <sub>f</sub>	S		18		V <sub>DS</sub> =20V, I <sub>D</sub> =40A	Fig.4
				17		V <sub>DS</sub> =20V, I <sub>D</sub> =40A, T <sub>j</sub> =175°C	

## ■ Dynamic Electrical Characteristics (Tc=25°C unless otherwise specified)

PARAMETER	SYMBOL	UNIT	Min.	Typ.	Max.	Test Conditions	Note
Input capacitance	C <sub>iss</sub>	pF		2225		V <sub>DS</sub> =1000V, V <sub>GS</sub> =0V, T <sub>j</sub> =25°C, f=1MHz, V <sub>AC</sub> = 25mV	Fig.13, 14
Output capacitance	C <sub>oss</sub>			141			
Reverse capacitance	C <sub>rss</sub>			15			
C <sub>oss</sub> stored energy	E <sub>oss</sub>	uJ		78		V <sub>DS</sub> =800V, V <sub>GS</sub> =-5/18V, I <sub>D</sub> =40A	Fig.15
Gate source charge	Q <sub>gs</sub>	nC		34			Fig.12
Gate drain charge	Q <sub>gd</sub>			42			
Gate charge	Q <sub>g</sub>			120			

## ■ Switching Characteristics (Tc=25°C unless otherwise specified)

PARAMETER	SYMBOL	UNIT	Min.	Typ.	Max.	Test Conditions	Note
Turn on switching energy	E <sub>on</sub>	uJ		692.6		V <sub>DD</sub> =800V, V <sub>GS</sub> =-5/+18V, I <sub>D</sub> =40A, R <sub>g</sub> =2.7Ω, L=100uH	Fig.21, 20
Turn off switching energy	E <sub>off</sub>			137.6			
Turn on delay time	t <sub>d(on)</sub>	ns		12.5		V <sub>DD</sub> =800V, V <sub>GS</sub> =-5/+18V, I <sub>D</sub> =40A, R <sub>g</sub> =2.7Ω, L=100uH	Fig.21, 20
Rise time	t <sub>r</sub>			25			

Turn off delay time	$t_{d(\text{off})}$	ns	30		$V_{DD}=800V, V_{GS}=-5/+18V, I_D=40A, R_g=2.7\Omega, L=100\mu H$	Fig.21, 20
Fall time	$t_f$		14.6			

■ **Body diode characteristics** ( $T_c=25^\circ C$  unless otherwise specified)

PARAMETER	SYMBOL	UNIT	Min.	Typ.	Max.	Test Conditions	Note
Diode forward voltage	$V_{SD}$	V		4.0		$V_{GS}=-5V, I_{SD}=20A$	Fig.8
				3.4		$V_{GS}=0V, I_{SD}=20A, T_j=175^\circ C$	Fig.9
Continuous diode forward current	$I_s$	A		60		$T_c=25^\circ C$	Note1
Reverse recovery time	$t_{rr}$	nS		54			
Reverse recovery charge	$Q_{rr}$	nC		283		$V_R=800V, V_{GS}=-5V, I_D=40A, dI/dt=1000A/\mu s$	
Peak reverse recovery current	$I_{rrm}$	A		15			

Note 1: When using SiC Body Diode the maximum recommended  $V_{GS} = -5V$

Note 2: MOSFET can also safely operate at 0/20 V

■ **Thermal Characteristics** ( $T_a=25^\circ C$  Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	Max.
Thermal resistance	$R_{\theta J-C}$	$^\circ C / W$	0.45

■ **Typical Characteristics**

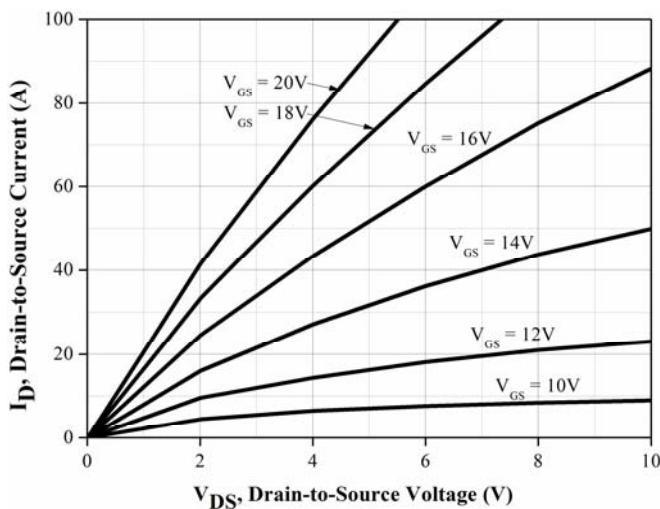


Figure 1. Output Characteristics  $T_j = -55^\circ C$

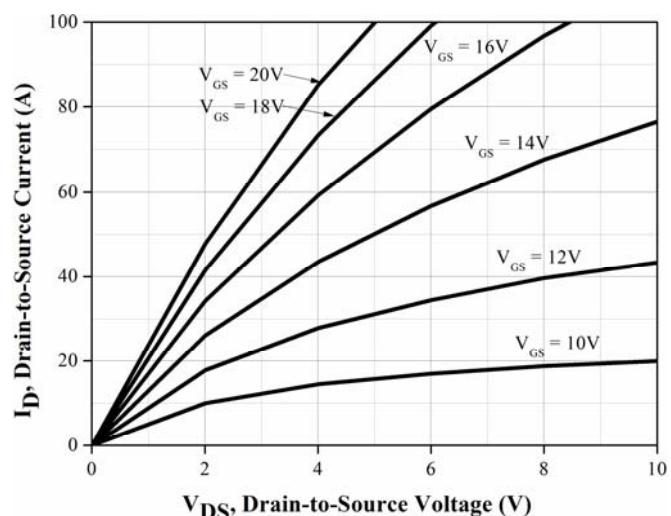
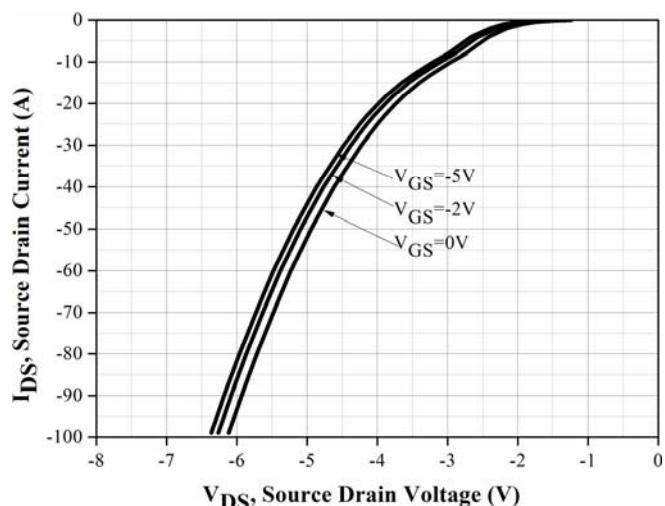
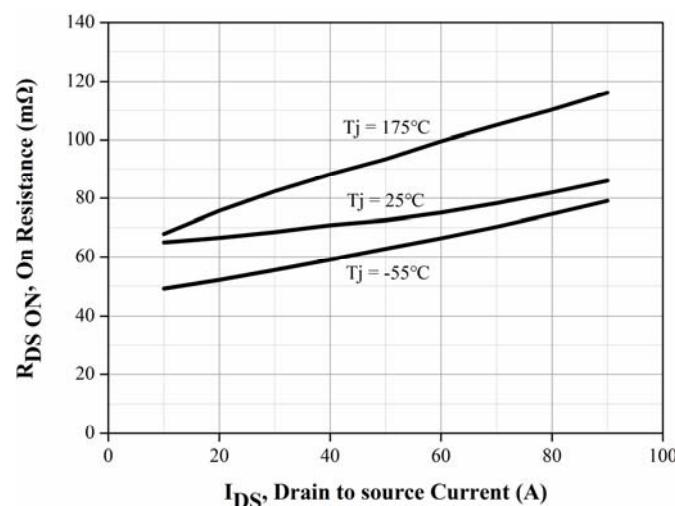
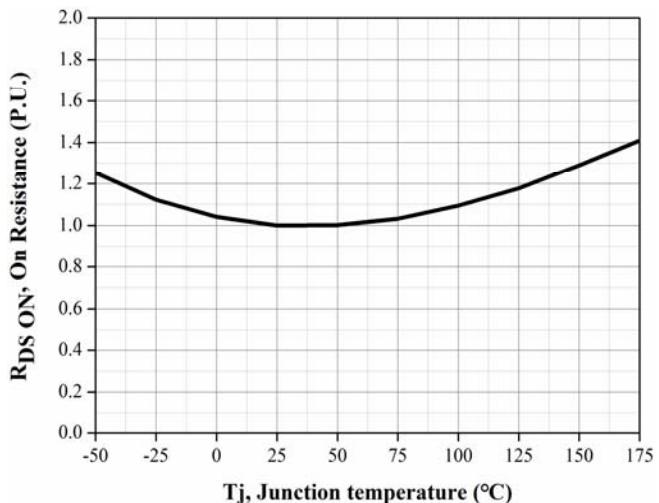
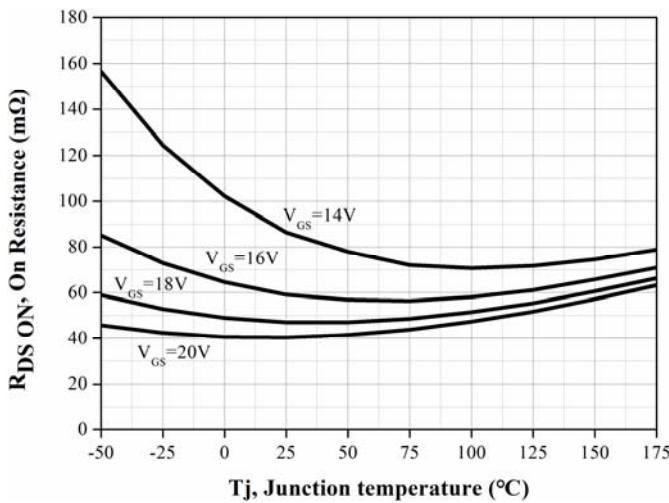
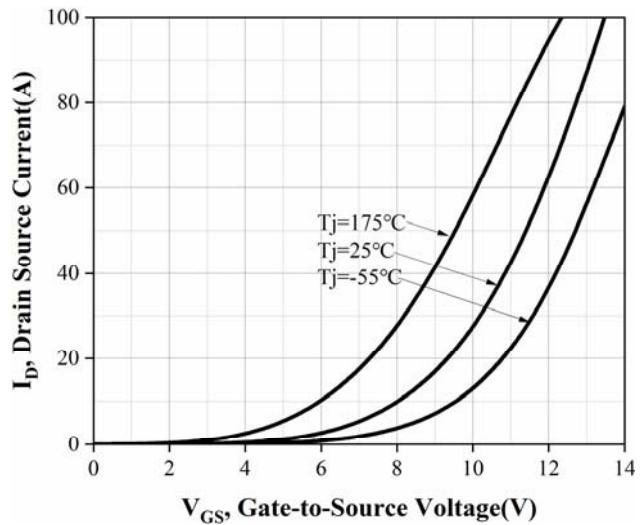
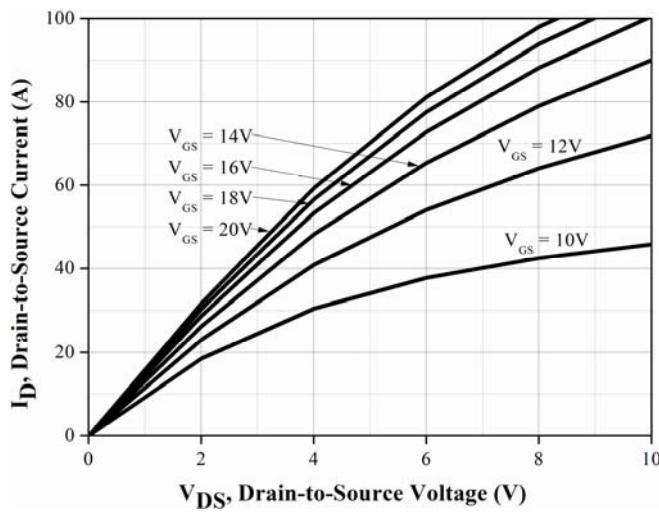


Figure 2. Output Characteristics  $T_j = 25^\circ C$



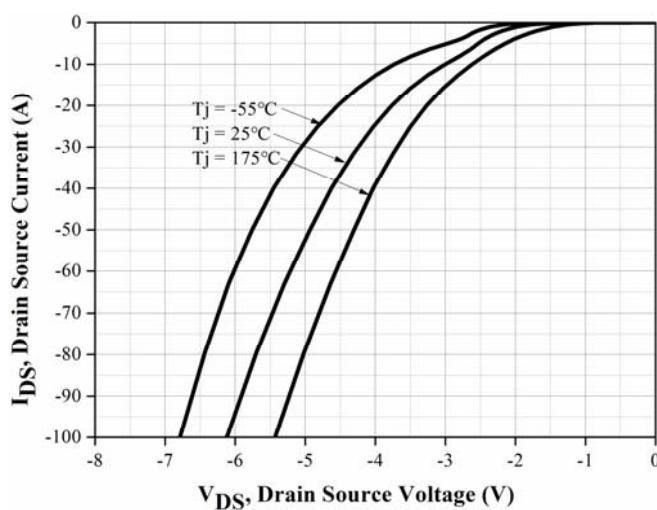


Figure 9. Body diode characteristic

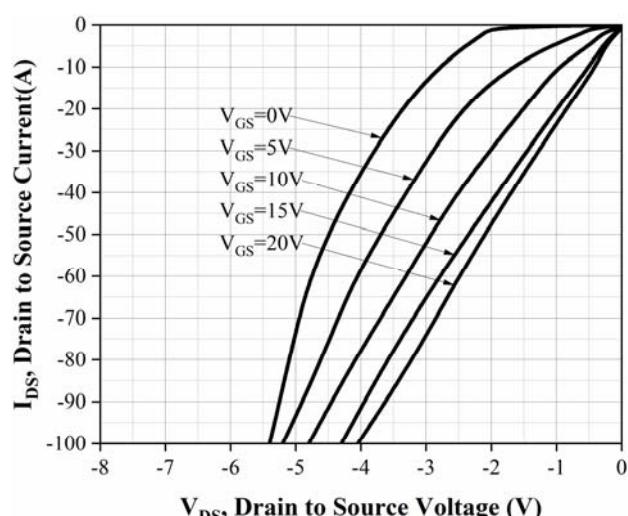
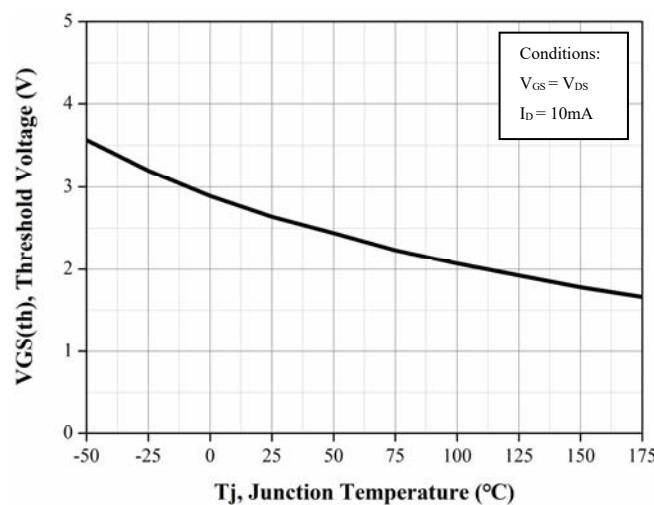
Figure 10. 3<sup>rd</sup> quadrant characteristic at  $T_j = 25^\circ\text{C}$ 

Figure 11. Threshold voltage vs. temperature

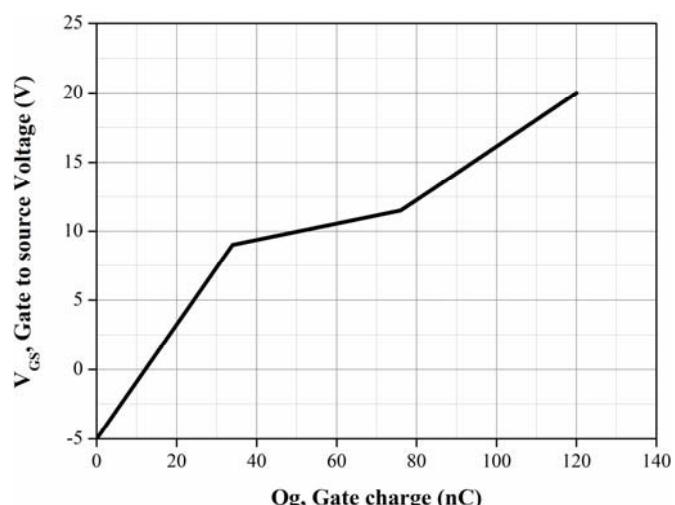


Figure 12. Gate charge characteristic

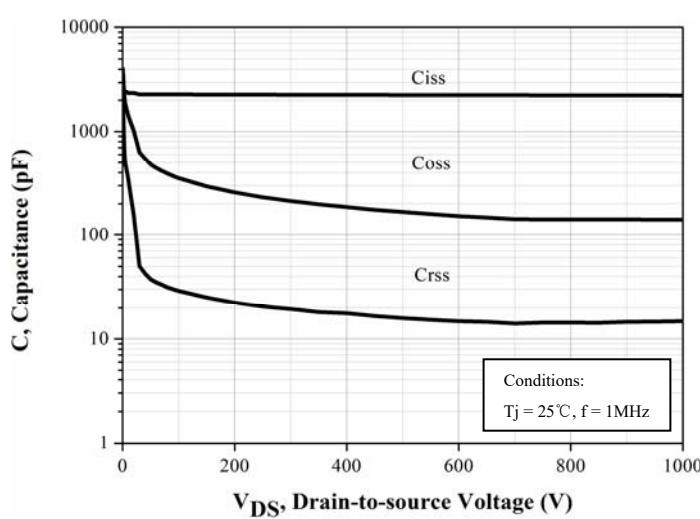


Figure 13. Capacitances vs. drain source voltage (0-1000V)

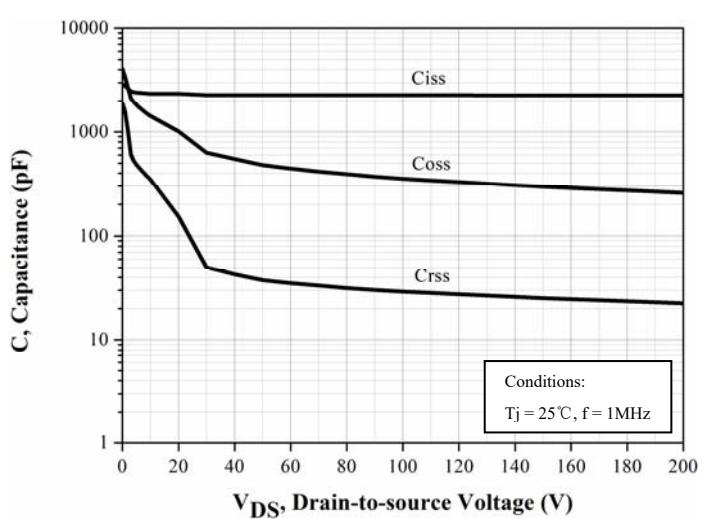


Figure 14. Capacitances vs. drain source voltage (0-200V)

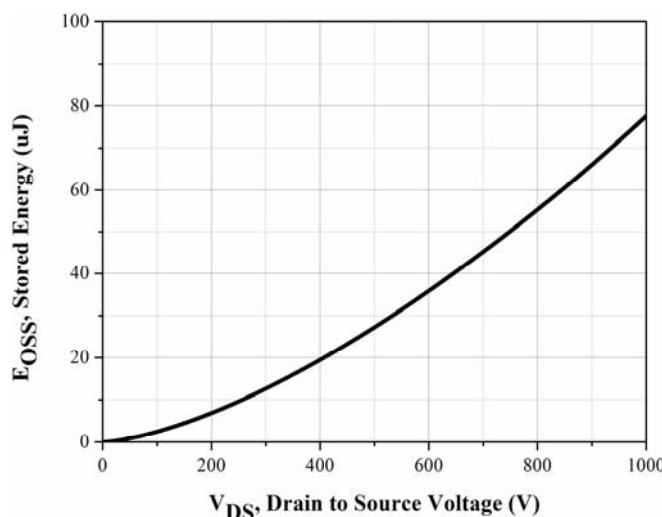


Figure 15. Output capacitor stored energy

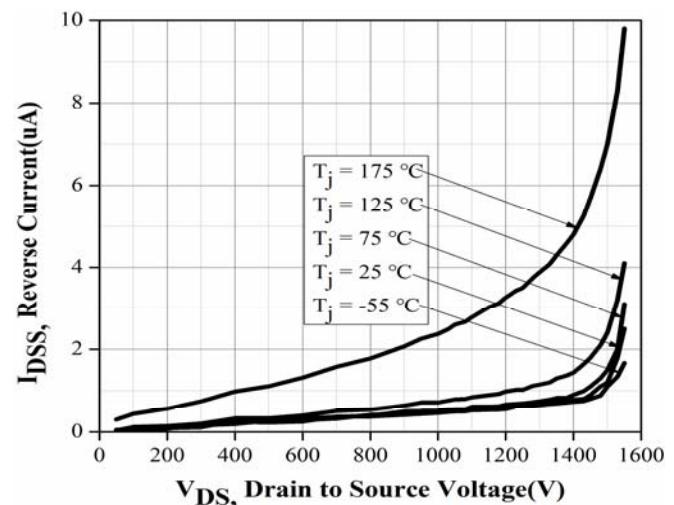
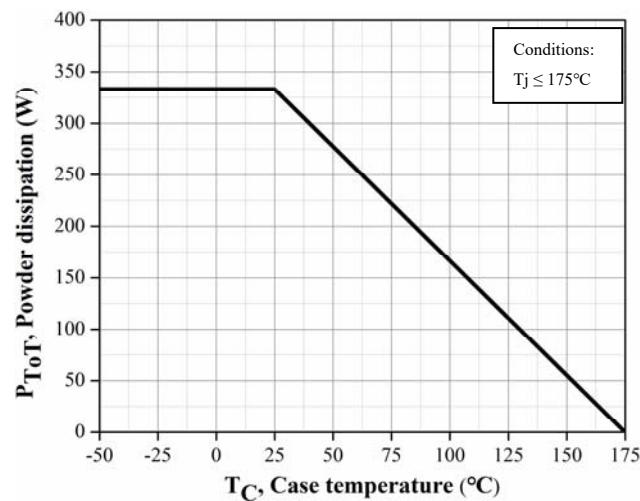
Figure 16. Reverse characteristics vs.  $T_j$ 

Figure 17. Maximum power dissipation derating vs. case temperature

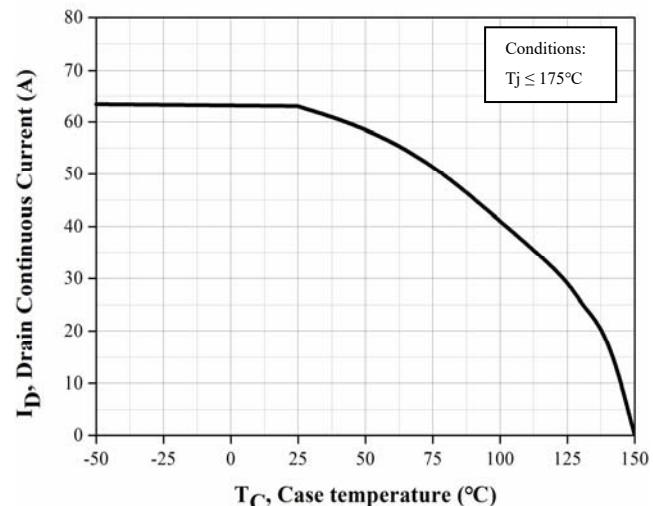


Figure 18. Continuous drain current derating vs. case temperature

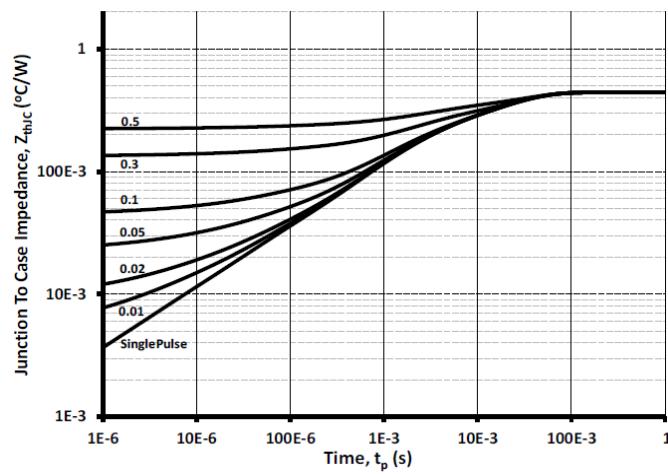


Figure 19. Transient thermal impedance (junction - case)

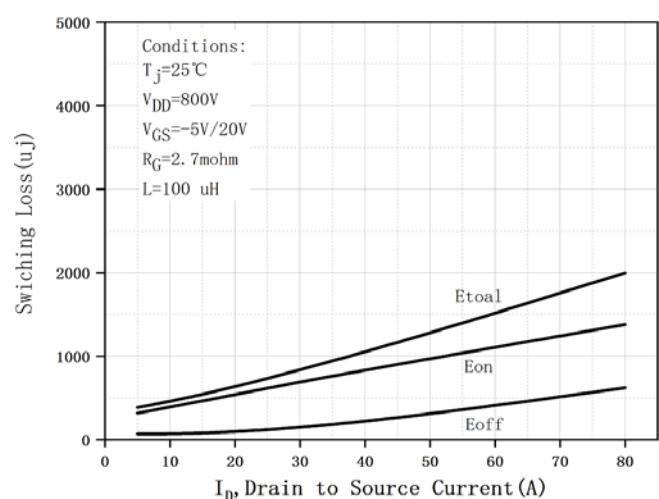


Figure 20. Clamped Inductive switching energy vs. drain current

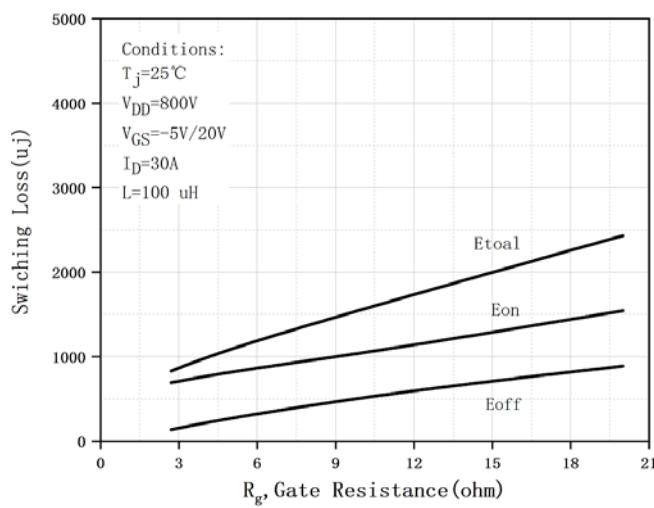
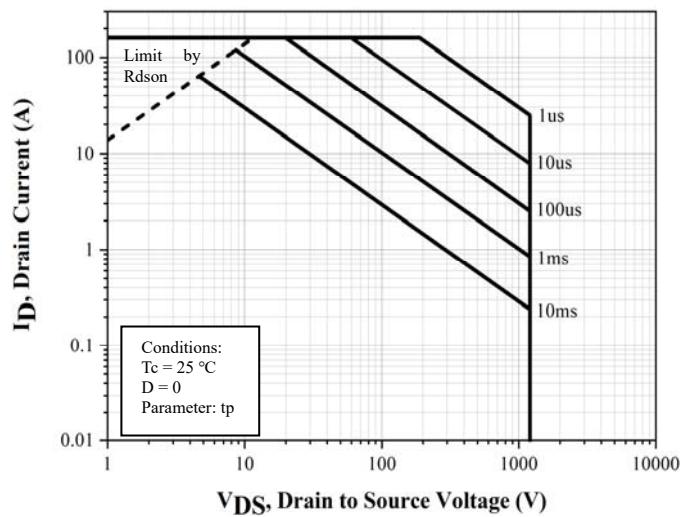
Figure 21. Clamped inductive switching energy vs.  $R_g$ 

Figure 22. Safe Operating Area

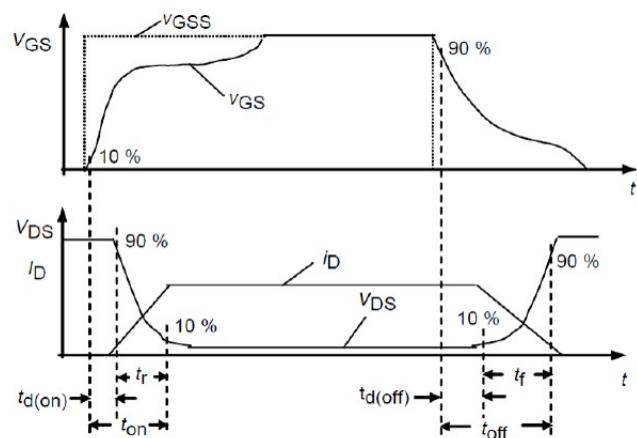


Figure 23. Switching Times Definition

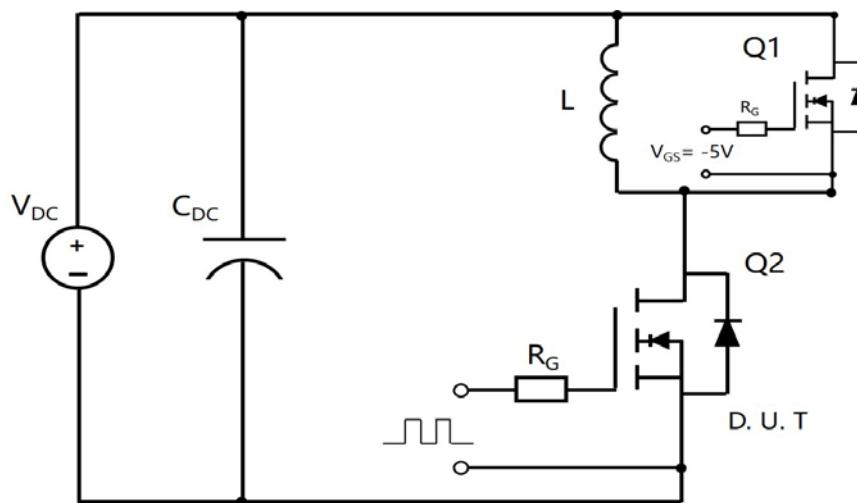
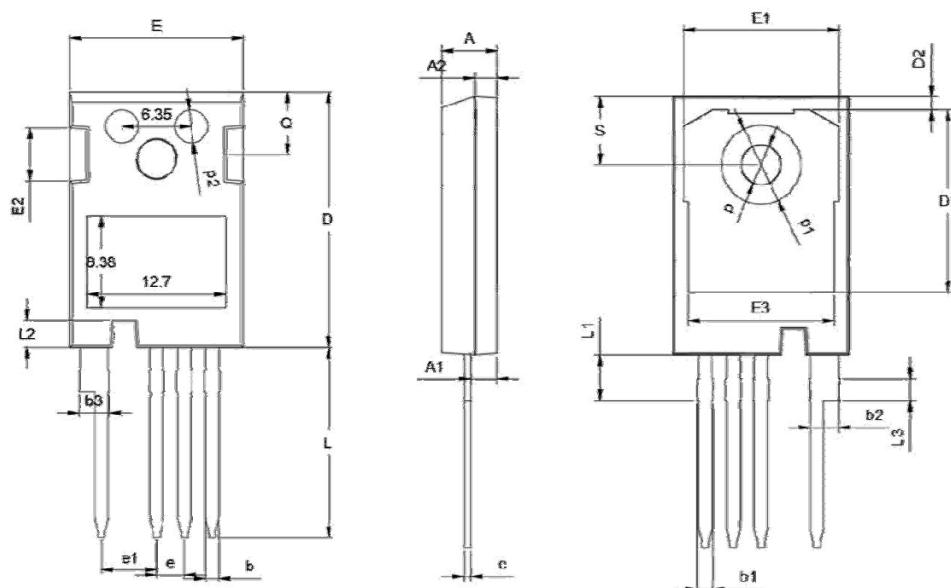


Figure 24. Clamped Inductive Switching Waveform Test Circuit

■Outline Dimensions



TO247-4L			
Dim	Min	Norm	Max
A	4.80	5.00	5.20
A1	2.30	2.40	2.50
A2	1.88	1.98	2.08
b	1.10	1.20	1.30
b1	1.20	/	1.50
b2	2.35	2.55	2.75
b3	2.45	/	2.85
c	0.55	0.60	0.65
D	23.3	23.45	23.6
D1	16.25	16.55	16.85
D2	1.00	/	1.30
e	TYP2.54		
e1	TYP5.06		
E	15.75	15.90	16.05
E1	13.80	/	14.20
E2	4.40	4.75	5.10
E3	13.00	/	13.45
L	17.34	17.49	17.64
L1	4.00	/	4.30
L2	2.35	/	2.65
L3	TYP1.98		
Q	5.60	5.80	6.00
S	6.05	/	6.30
p	TYP3.58		
p1	TYP7.18		
p2	TYP3.00		

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